



RF360  
Europe GmbH

## Data sheet

### SAW RF filter

Automotive telematics  
WLAN 2G

Series/type: B4347

Ordering code: B39242B4347P810

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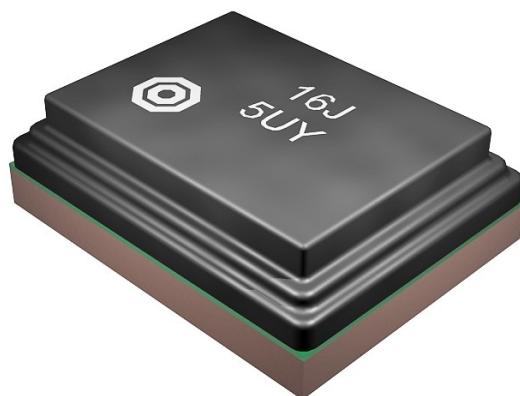
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## 1 Application

- Low-loss RF filter for Bluetooth/WLAN
- Usable pass band 83.5MHz

## 2 Features

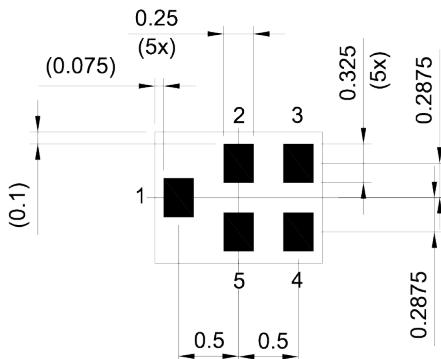
- Package size  $1.4 \pm 0.1$  mm  $\times$   $1.1 \pm 0.1$  mm
- Package height 0.45 mm (max.)
- Approximate weight 3 mg
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Filter surface passivated
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 2a (MSL2a)
- AEC-Q200 qualified component family  
(Grade 1:  $-40$  °C to  $+125$  °C)



**Figure 1:** Picture of component with example of product marking.

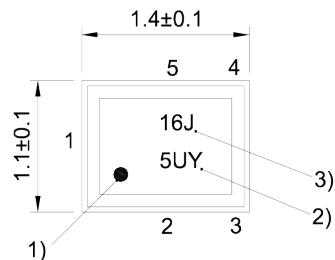
### 3 Package

## BOTTOM VIEW



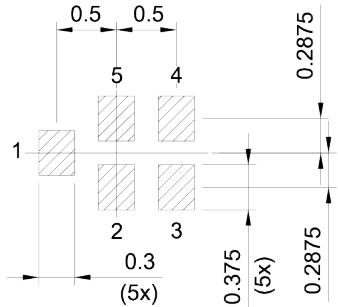
Pad and pitch tolerance  $\pm 0.05$

### SIDE VIEW



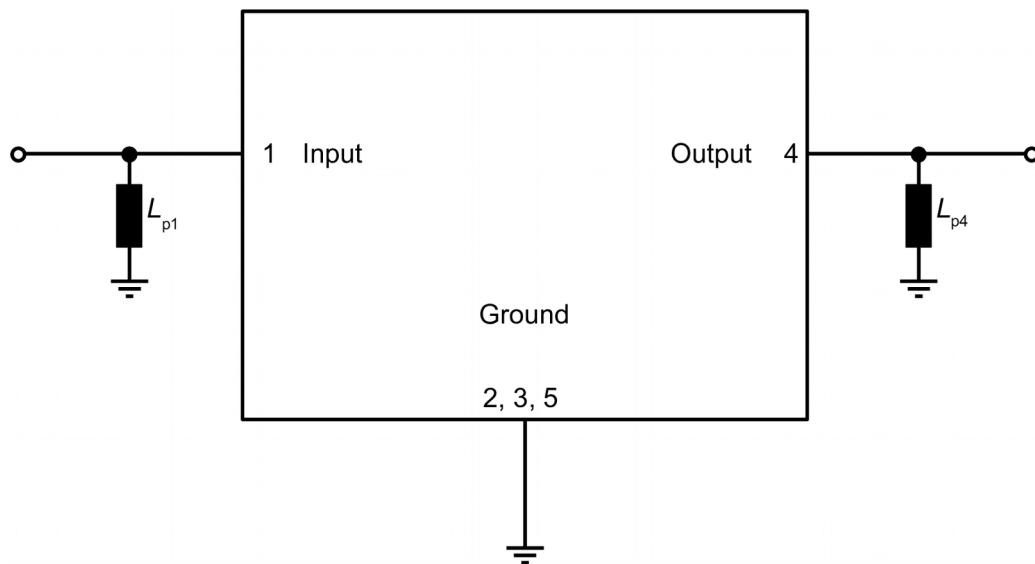
- 1) Marking for pad number 1
- 2) Example of encoded lot number
- 3) Example of encoded filter type number

Land pattern  
THRU VIEW



Landing pad tolerance -0.02

**Figure 2:** Drawing of package with package height A = 0.45 mm (max.). See Sec. Package information (p. 18).

**5 Matching circuit****■  $L_{p1} = 4.3 \text{ nH}$** **■  $L_{p4} = 4.7 \text{ nH}$** **Figure 3:** Schematic of matching circuit.

## 6 Characteristics

Temperature range for specification	$T_{\text{SPEC}}$	= -40 °C ... +105 °C
Input terminating impedance	$Z_{\text{IN}}$	= 50 Ω // 4.3 nH <sup>1)</sup>
Output terminating impedance	$Z_{\text{OUT}}$	= 50 Ω // 4.7 nH <sup>1)</sup>

Characteristics			min. for $T_{\text{SPEC}}$	typ. @ +25 °C	max. for $T_{\text{SPEC}}$	
<b>Center frequency</b>		$f_c$	—	2441.75	—	MHz
<b>Maximum insertion attenuation</b>		$\alpha_{\text{max}}$	—	1.8	2.7	dB
2400 ... 2483.5 MHz						
<b>Amplitude ripple (p-p)</b>		$\Delta\alpha$	—	0.6	1.5	dB
2400 ... 2483.5 MHz						
<b>Maximum VSWR</b>		$\text{VSWR}_{\text{max}}$	—			
@ input port	2400 ... 2483.5 MHz		—	1.6	2.2	
@ output port	2400 ... 2483.5 MHz		—	1.6	2.2	
<b>Minimum attenuation</b>		$\alpha_{\text{min}}$	—			
50 ... 1000 MHz			36	42	—	dB
1000 ... 2100 MHz			28	33	—	dB
2100 ... 2320 MHz			28	35	—	dB
2320 ... 2332.5 MHz			38	44	—	dB
2332.5 ... 2345 MHz			33	40	—	dB
2600 ... 3100 MHz			30	40	—	dB
3100 ... 4000 MHz			30	40	—	dB
4000 ... 5000 MHz			37	45	—	dB

<sup>1)</sup> See Sec. Matching circuit (p. 6).

## 7 Maximum ratings

Operable temperature	$T_{OP} = -40 \text{ }^{\circ}\text{C} \dots +125 \text{ }^{\circ}\text{C}$	
Storage temperature	$T_{STG}^{1)} = -40 \text{ }^{\circ}\text{C} \dots +125 \text{ }^{\circ}\text{C}$	
DC voltage	$ V_{DC} ^{2)} = 0 \text{ V (max.)}$	
Input power @ input port: 2400 ... 2483.5 MHz	$P_{IN} = 24 \text{ dBm}$	Continuous wave for 1000 h @ 95 °C.

<sup>1)</sup> Not valid for packaging material. Storage temperature for packaging material is -25 °C to +40 °C.

<sup>2)</sup> In case of applied DC voltage blocking capacitors are mandatory.

#### 8 Transmission coefficient

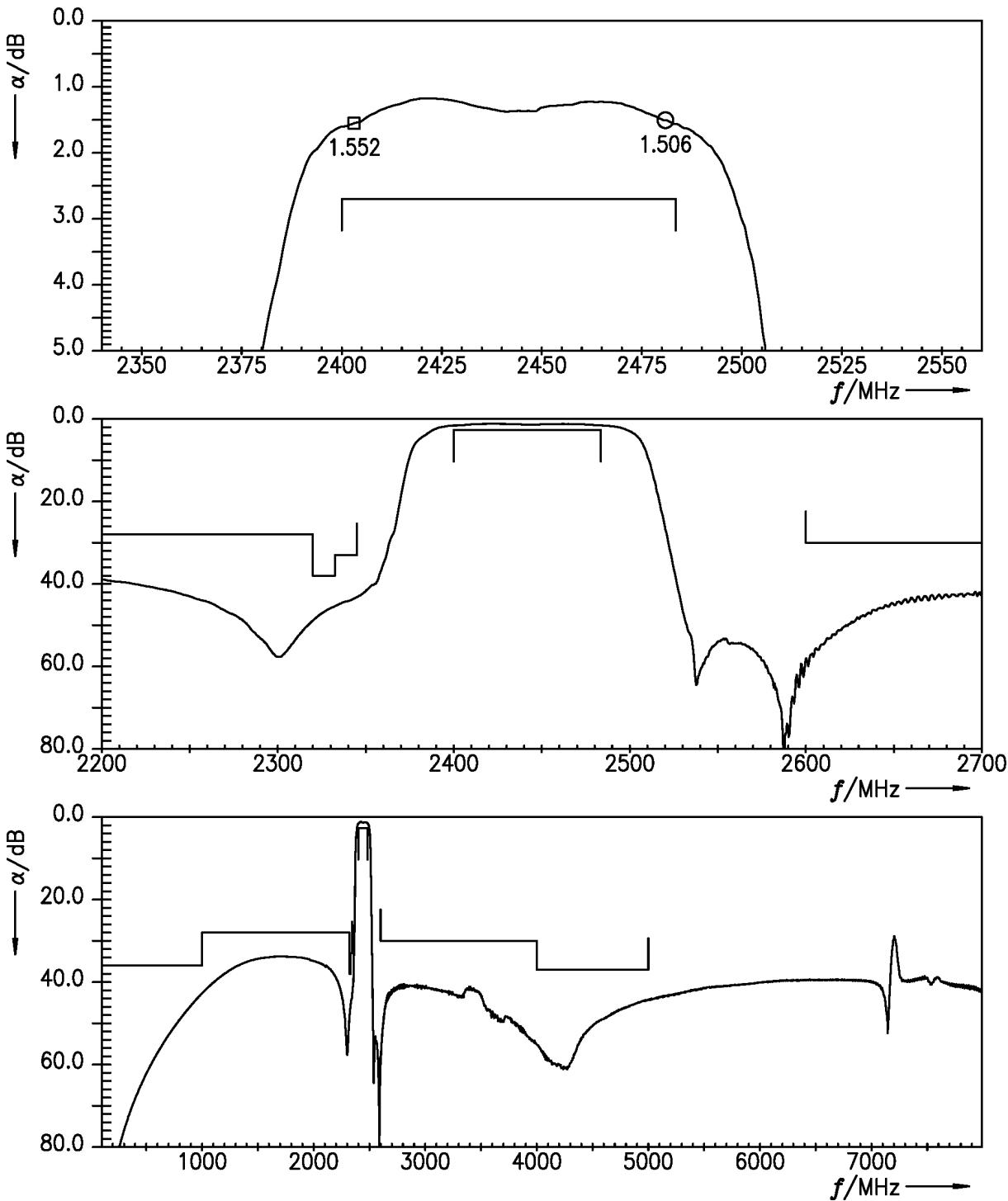


Figure 4: Attenuation.

## 9 Reflection coefficients

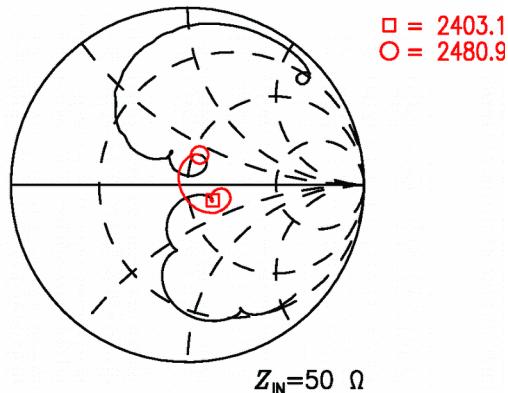
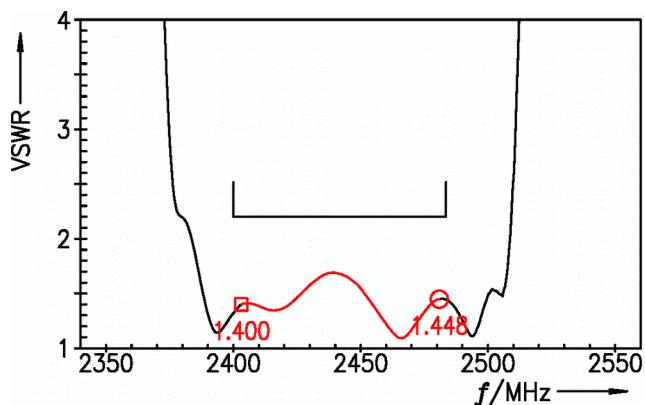


Figure 5: Reflection coefficient at input port.

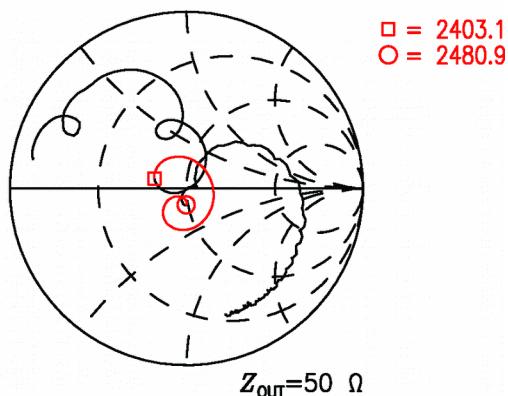
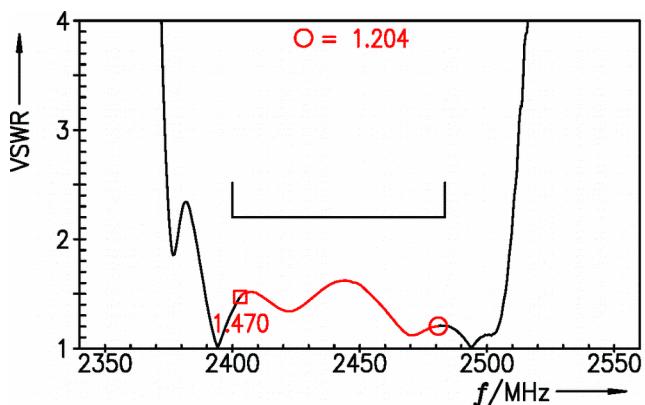
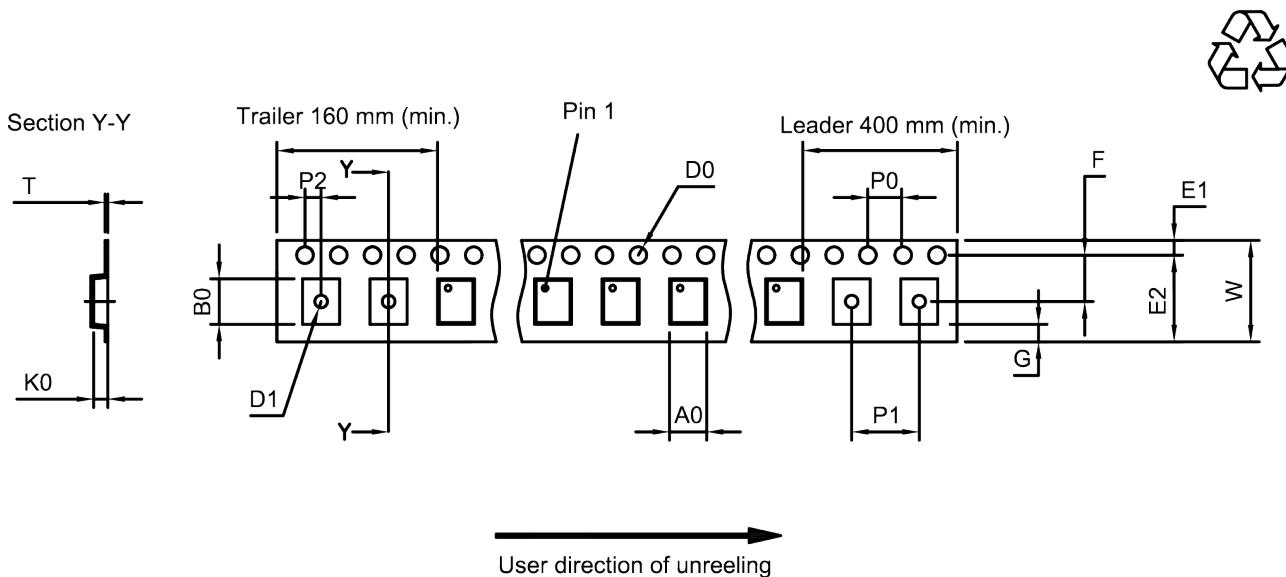


Figure 6: Reflection coefficient at output port.

## 10 Packing material

### 10.1 Tape



**Figure 7:** Drawing of tape (first-angle projection) for illustration only and not to scale. The valid tape dimensions are listed in Table 1.

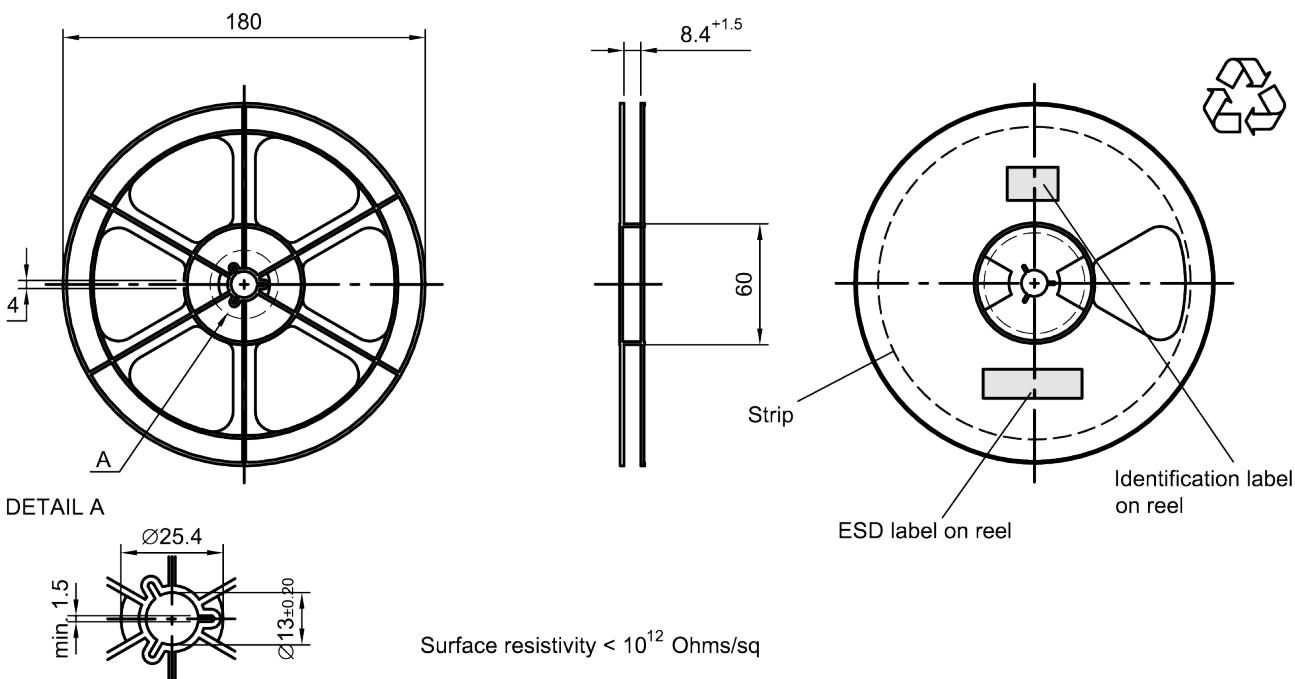
$A_0$	$1.27 \pm 0.05$ mm
$B_0$	$1.57 \pm 0.05$ mm
$D_0$	$1.5 \pm 0.1$ mm
$D_1$	$0.5 \pm 0.1$ mm
$E_1$	$1.75 \pm 0.1$ mm

$E_2$	6.25 mm (min.)
$F$	$3.5 \pm 0.05$ mm
$G$	0.75 mm (min.)
$K_0$	$0.62 \pm 0.05$ mm
$P_0$	$4.0 \pm 0.1$ mm

$P_1$	$4.0 \pm 0.1$ mm
$P_2$	$2.0 \pm 0.05$ mm
$T$	$0.25 \pm 0.03$ mm
$W$	$8.0 \pm 0.3$ mm

**Table 1:** Tape dimensions.

#### 10.2 Reel with diameter of 180 mm



**Figure 8:** Drawing of reel (first-angle projection) with diameter of 180 mm.

Dimensions [mm]

X = 220+5

Y = 235+5

Sealing area 10±3

Printing on vacuumbag



Vacuumbag

Sealing area

Drypack in vacuumbag

Identification label on vacuumbag

Humidity indicator in vacuumbag

**Figure 9:** Drawing of moisture barrier bag (MBB) for reel with diameter of 180 mm.

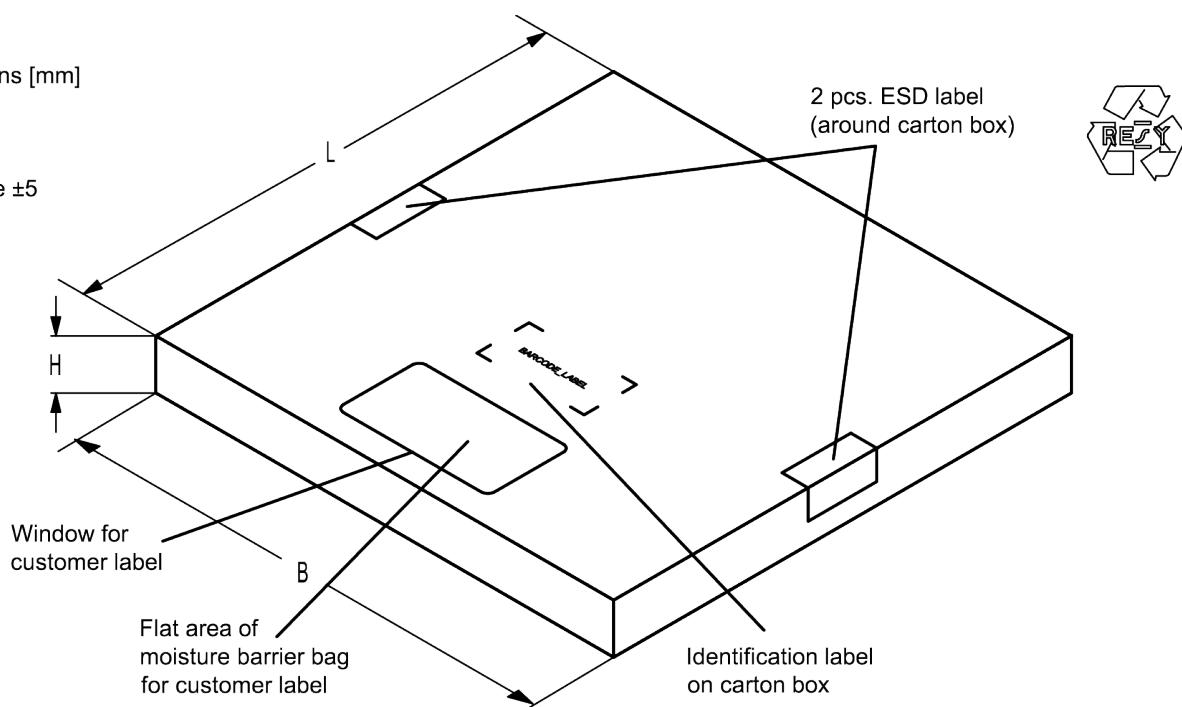
Dimensions [mm]

L = 188

B = 188

H = 30

Tolerance  $\pm 5$



**Figure 10:** Drawing of folding box for reel with diameter of 180 mm.

## 11 Marking

Products are marked with product type number and lot number encoded according to Table 2:

### ■ Type number:

The 4 digit type number of the ordering code,  
is encoded by a special BASE32 code into a 3 digit marking.

e.g., B3xxxxB**1234**xxxx,

Example of decoding type number marking on device  
 $16J$   $\Rightarrow$  **1234**  
 $1 \times 32^2 + 6 \times 32^1 + 18 (=J) \times 32^0$   $=$  **1234**

The BASE32 code for product type B4347 is 47V.

in decimal code.

### ■ Lot number:

The last 5 digits of the lot number,  
are encoded based on a special BASE47 code into a 3 digit marking.

e.g., **12345**,

Example of decoding lot number marking on device

in decimal code.

$5UY$   $\Rightarrow$  **12345**  
 $5 \times 47^2 + 27 (=U) \times 47^1 + 31 (=Y) \times 47^0$   $=$  **12345**

Adopted BASE32 code for type number			
Decimal value	Base32 code	Decimal value	Base32 code
0	0	16	G
1	1	17	H
2	2	18	J
3	3	19	K
4	4	20	M
5	5	21	N
6	6	22	P
7	7	23	Q
8	8	24	R
9	9	25	S
10	A	26	T
11	B	27	V
12	C	28	W
13	D	29	X
14	E	30	Y
15	F	31	Z

Adopted BASE47 code for lot number			
Decimal value	Base47 code	Decimal value	Base47 code
0	0	24	R
1	1	25	S
2	2	26	T
3	3	27	U
4	4	28	V
5	5	29	W
6	6	30	X
7	7	31	Y
8	8	32	Z
9	9	33	b
10	A	34	d
11	B	35	f
12	C	36	h
13	D	37	n
14	E	38	r
15	F	39	t
16	G	40	v
17	H	41	\
18	J	42	?
19	K	43	{
20	L	44	}
21	M	45	<
22	N	46	>
23	P		

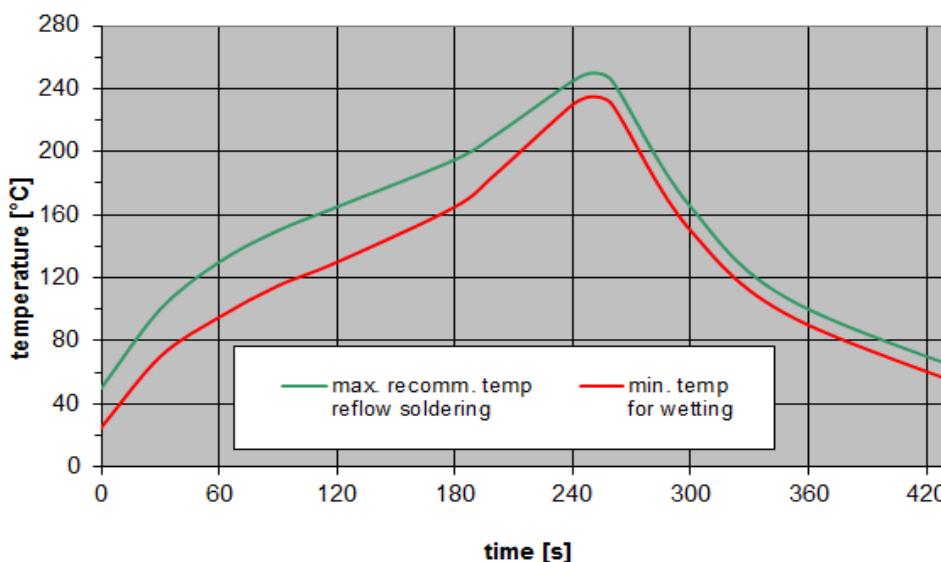
Table 2: Lists for encoding and decoding of marking.

## 12 Soldering profile

The recommended soldering process is in accordance with IEC 60068-2-58 – 3<sup>rd</sup> edit and IPC/JEDEC J-STD-020B.

ramp rate	$\leq 3 \text{ K/s}$
preheat	125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s
$T > 220 \text{ }^{\circ}\text{C}$	30 s to 70 s
$T > 230 \text{ }^{\circ}\text{C}$	min. 10 s
$T > 245 \text{ }^{\circ}\text{C}$	max. 20 s
$T \geq 255 \text{ }^{\circ}\text{C}$	–
peak temperature $T_{\text{peak}}$	250 °C +0/-5 °C
wetting temperature $T_{\text{min}}$	230 °C +5/-0 °C for 10 s $\pm 1$ s
cooling rate	$\leq 3 \text{ K/s}$
soldering temperature $T$	measured at solder pads

**Table 3:** Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).



**Figure 11:** Recommended reflow profile for convection and infrared soldering – lead-free solder.

### 13 ESD protection of SAW filters

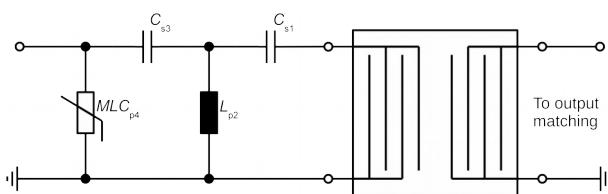
SAW filters are **Electro Static Discharge** sensitive devices. To reduce the probability of damages caused by ESD, special matching topologies have to be applied.

In general, “ESD matching” has to be ensured at that filter port, where electrostatic discharge is expected.

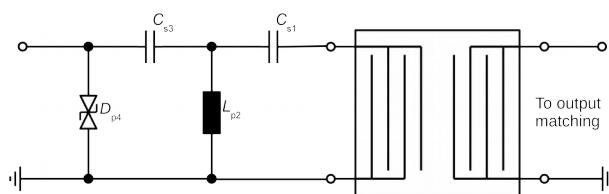
Electrostatic discharges predominantly appear at the antenna input of RF receivers. Therefore, only the input matching of the SAW filter has to be designed to short circuit or to block the ESD pulse.

Below three figures show recommended “ESD matching” topologies.

For wide band filters the high-pass ESD matching structure needs to be at least of 3<sup>rd</sup> order to ensure a proper matching for any impedance value of antenna and SAW filter input. The required component values have to be determined from case to case.

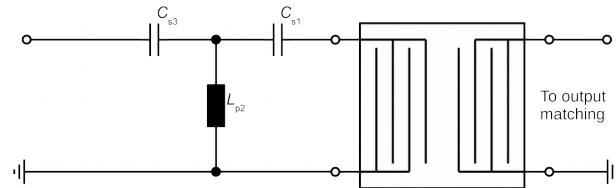


**Figure 12:** MLC varistor plus ESD matching.



**Figure 13:** Suppressor diode plus ESD matching.

In cases where minor ESD occur, following simplified “ESD matching” topologies can be used alternatively.



**Figure 14:** 3<sup>rd</sup> order high-pass structure for basic ESD protection.

In all three figures the shunt inductor  $L_{p2}$  could be replaced by a shorted microstrip with proper length and width. If this configuration is possible depends on the operating frequency and available PCB space.

Effectiveness of the applied ESD protection has to be checked according to relevant industry standards or customer specific requirements.

For further information, please refer to RF360 Application report: “**ESD protection for SAW filters**”. This report can be found under <https://rfe.qualcomm.com>.

## 14 Annotations

### 14.1 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

### 14.2 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local RF360 sales office.

## 15 Cautions and warnings

### 15.1 Display of ordering codes for RF360 products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of RF360, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under <https://rffe.qualcomm.com/>.

### 15.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

For information on recycling of tapes and reels please contact one of our sales offices.

### 15.3 Moldability

Before using in overmolding environment, please contact your local RF360 sales office.

### 15.4 Package information

#### Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on RF360 internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of RF360, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

#### Dimensions

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

Dimensions do not include burrs.

#### Projection method

Unless otherwise specified first-angle projection is applied.

## 16 Important notes

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